Boundary conditions for the electronic structure of nite-extent, em bedded sem iconductor nanostructures

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Abstract

Them odeling of nite-extent sem iconductor nanostructures that are embedded in a host material requires a proper boundary treatment for a nite simulation domain. For the study of a self-assem bled InA s dot embedded in G aAs, three kinds of boundary conditions are examined within the empirical tight-binding model: (i) the periodic boundary condition, (ii) raising the orbital energies of surface atoms, and (iii) raising the energies of dangling bonds at the surface. The periodic boundary condition requires a sm ooth boundary and consequently a larger G aAs bu er than the two non-periodic boundary conditions. Between the non-periodic conditions, the dangling-bond energy shift is more num erically e cient than the orbital-energy shift, in terms of the elimination of non-physical surface states in the energy region of interest for interior states. A dangling-bond energy shift larger than 5 eV e ciently eliminates all of the surface states and leads to interior states that are highly insensitive to the choice of the energy shift.

I. IN TRODUCTION

The representation of a sem iconductor heterostructure by an atom istic m odel ultim ately requires the introduction of a lim ited simulation dom ain, of which the surface needs to be treated with a speci c boundary condition (BC). If the surface of the simulation dom ain is selected far enough from the central feature of interest, periodic BCs can be used and the simulation dom ain is e ectively repeated in nitely. However, for electronic devices with non-periodic external potentials or for structures with inregular surfaces, the periodic BCs are not a natural choice. If the simulation-dom ain surface is within the material bulk region, a truly open BC or perfectly absorbing BC would be the best solution, as it does not introduce an articial periodicity and would enable the simulation of carrier in jection or transport.[1, 2] How ever such a BC requires the inversion of a full matrix that is of the order of the number of atom s on the open surface. Therefore, the open BC can only be applied to relatively small open surfaces.

Another choice in representing a nite simulation dom ain is the abrupt term ination of the simulation dom ain with a hard-wall BC. Such abrupt term ination in the atom istic basis set results in the creation of dangling bonds. The dangling bonds will form surface states (of the order of the number of exposed atom s), that typically cover a broad energy range and often litter the central energy region of the fundam ental band gap. The separation of the arti cially introduced surface states from the desired centrally con ned states is num erically expensive, as the computation time and required memory increase with the number of computed eigenvalues and eigenvectors and as the separation would dem and the computation of eigenvectors. Many relevant quantum dot calculations only require the computation of eigenvalues, β] while the computation of the eigenvectors at least doubles the computation time and the required memory scales with the number of computed eigenvectors. To address the problem of arti cially introduced surface states, this paper examines two modi ed hardwall BC s and discusses their merits relative to each other and to the more standard periodic BC.

Typical quantum -dot and heterostructure devices are based on the concept of con ning electron and hole states into a spatial dom ain. The con nem ent is typically achieved by surrounding a core sem iconductor by a bu er sem iconductor of larger band gap. The practical question now arises of how large of a bu er region must be included in the explicit

sin ulation dom ain. In systems of strain-induced self-assembled quantum dots the strain elds m ay extend out from the central device region for tens of nanom eters, [4] while the quantum states of interest extend only over a few atom ic monolayers into the bu er. The lattice distortion due to strain must therefore be computed in a large simulation dom ain, while the desired quantum con ned states may only need to be computed in a relatively sm all simulation dom ain. The hard wall BCs considered in this paper enable the strain and electronic structure simulations to be performed with two diments in ulation dom ains. This paper demonstrates that the inclusion of a realistically large bu er is essential to capture the e ects of strain, while the subsequent electronic structure calculation can then be performed with a signi cantly sm aller, strain distorted simulation dom ain which resolves the con ned quantum states of interest. The reduction of the simulation dom ain for the electronic structure calculation substantially lessens the computational requirements since the dimension of the Ham iltonian grows linearly with the number of atoms included in the model.

The proper BC for a reduced bu er should e ciently eliminate all non-physical surface states and at the same time should minimally a ect physical interior states. In previous work, two types of BC have been considered for the atom istic modeling of embedded nanostructures.[4, 5] In the rst BC, the orbital energy of the surface atom s is raised by a speci c am ount.[4] The value of energy shift is determ ined em pirically by requiring that no state resides in the energy gap.[4] W e will show that this method is unpredictable and num erically less e cient than the new BC proposed in this work. The second BC found in the literature is the periodic BC with a truncated bu er.[5] We also nd this method ine cient in elim inating spurious states form ed in the energy gap region as it requires either a relatively larger bu er or an unphysical, em pirical ad justm ent to atom ic positions near the boundary for a sm all bu er. In the present work, we propose a new BC that is to raise the energy of dangling bonds. We compare the proposed BC with the two previously employed BCs and dem onstrate the e ciency and reliability of the new BC. The three boundary conditions are applied to the study of the electronic structure of a self-assem bled InAs quantum dot em bedded in a G aA s bu er in the fram ew ork of the em pirical tight-binding m odel. The e ciency and reliability of the BCs are measured by the elim ination of non-physical surface states, the number of iterations in the Lanczos eigenvalue solver, and the reduction of the bu er size required for interior-state energy convergence.

II. BOUNDARY CONDITIONS

The rst boundary condition (BC I) considered is to raise the orbital energies of surface atom s. This method discourages electrons from populating the surface-atom orbitals. How – ever, this treatment does not dimensioned details of the surface atom s such as the number and direction of their dangling bonds. As a remement, a second boundary condition (BC II) is introduced: raising the energy of the dangling bond for the surface atom s. Within this method, the connected-bond energy of the surface atom s is kept unchanged and hence there is no extra penalty for electrons to occupy the connected bonds of surface atom s. Since the motivation of the surface energy shift in BC I and II is to remove non-physical surface states from the energy region of interest, low ering the surface energies will have the same outcome as raising the surface energies.

Both BC I and II are closed boundary conditions as opposed to a periodic condition that is the third boundary condition (BC III) considered in this work. In principle, this boundary condition is applicable only if the system is composed of a unit cell periodically repeated. However, the periodic boundary condition is widely used not only for periodic system s but also for system s with non-periodic perturbations such as alloy disorder, defects, in purities, and even surfaces. For system s with such non-periodic perturbations, the unit cell known as the supercell should be large enough to accom m odate the non-periodic perturbations. In nanostructure m odeling, the supercell can be as large as the whole size of the nanostructures. For instance, the nanostructure composed of a quantum dot and a surrounding bu er has no inherent periodicity, with a long-ranged strain eld that extends up to tens of nanom eters.[4] The periodic boundary condition is therefore exam ined for its appropriateness and e ciency in m odeling these nanostructures.

These three boundary conditions are implemented in the framework of the orthogonal nearest-neighbor tight-binding model. In this model, the elective Hamiltonian is expressed as the sum of the couplings between atom ic basis orbitals ji; i:

$$H_{0} = X \qquad X \qquad X \qquad t_{ii^{0}} \circ ji; ihi^{0}; {}^{0}j; \qquad (1)$$

where indices i and denote an atom ic site and an orbital type. Parameter represents the energy of the basis orbital, and t accounts for the coupling between basis orbitals centered at nearest-neighbor atom ic sites.

In BC I, the Hamiltonian block matrix for a surface atom with basis set $f_{p_x}i_{p_y}i_{p_z}j_{p_z}i_{p_$

where is the energy shift for the orbital on a surface atom . A dierent energy shift can be chosen for each basis orbital.

For BC II, the basis set of the Ham iltonian is rst changed from set fjsi; $\dot{p}_x i$; $\dot{p}_y i$; $\dot{p}_z ig$ to the set of sp³ hybridized orbitals that are aligned along the bond directions. In the zinc-blende structure, the sp³ hybridized orbitals are given by [6]

$$jsp_{a}^{3}i = \frac{1}{2} (jsi + j_{x}i + j_{y}i + j_{z}i);$$

$$jsp_{b}^{3}i = \frac{1}{2} (jsi + j_{x}i + j_{y}i + j_{z}i);$$

$$jsp_{c}^{3}i = \frac{1}{2} (jsi + j_{x}i + j_{y}i + j_{z}i);$$

$$jsp_{d}^{3}i = \frac{1}{2} (jsi + j_{x}i + j_{y}i + j_{z}i);$$

$$(3)$$

The energy of a hybridized orbital is raised by $_{sp^3}$ if the orbital is along the dangling bond direction. For instance, if the surface atom has dangling bonds along jsp_a^3i and jsp_c^3i directions, the Ham iltonian block matrix for the surface atom in the basis set $fjsp_a^3i$; jsp_b^3i ; jsp_b^3i ; jsp_d^3i is given by

$$a + sp^{3} b b b_{7}$$

$$b a b b_{7}$$

$$b b a + sp^{3} b_{7}$$

$$b b b a$$

$$(4)$$

where a = s=4+3 p=4 and b = s=4 p=4.

Finally, the Hamiltonian is transformed back into the original basis set of fjsi; $\dot{p}_x i$; $\dot{p}_y i$; $\dot{p}_z i$ g. The nalHamiltonian block matrix for the surface atom becomes

In comparison with Eq. (2), this block matrix contains nonzero o -diagonal elements. Furthermore, the shift of the diagonal element is proportional to the number of dangling bonds. If the surface atom has n dangling bonds, the energy shift of the diagonal elements is given by n $_{sp^3}=4$. This shows that BC II distinguishes among surface atom swith a di erent number of dangling bonds. It is important to note that BC II becomes identical to BC I when the energies of all the four sp³ hybridized orbitals are raised by the same amount. Therefore, BC I can be interpreted as the boundary condition that truncates the dangling bonds as well as the bonds connected to interior atom s.

To some degree, BC II m in ics the physical passivation of dangling bonds with other atom s such as hydrogen and oxygen. Experimentally, silicon surfaces are usually passivated by hydrogen to improve the conductivity. The hydrogen form s bonding and anti-bonding states with the dangling bonds of Si at the surface. For example, the energies of the bonding and anti-bonding states of SiH₄ are about 18 eV and 5 eV below the valence band edge of bulk Si, respectively.[7] Therefore, hydrogen passivation e ciently removes surface states localized in dangling bonds. In connection with this mechanism, BC II can be interpreted as the approximate form ation of the bonding and antibonding states between a dangling bond and vacuum at an energy determined by sp^3 .[8]

A though BC I and II can be also applied to excited orbitals such as d and s, it is unnecessary to shift the energies of the excited orbitals for surface atoms. The atom ic energies of the excited orbitals (typically $10\{20 \text{ eV}\}$) are larger than the energy gap, which is typically $0\{5 \text{ eV}, 9\}$ Furtherm ore, the bonding states between the excited orbital and the s=p orbital are shifted up by the energy shift of the s=p orbitals. Therefore, the unm odi ed excited orbitals of surface atom s do not lead to surface states in the m iddle of the energy gap.

In plementing BC I and II requires a proper choice for the energy shift of the surface atom s. The energy shift should be high enough to discourage electrons from occupying the surface atom orbitals and consequently to eliminate all non-physical surface states in the middle of the gap. The diagonal elements of the tight-binding Ham iltonian give a guide to the required energy shift. The diagonal elements range from 0.6 eV to 20 eV. The sensitivity of the electronic structure to di erent energy shifts s, p, and sp³ is discussed in Section IV D.

Finally for BC III (the periodic boundary condition), every surface atom is connected

with another surface atom on the opposite side of the supercell. Consequently, the coupling between surface atoms from the two sides is added to the original Ham iltonian:

$$H_{\text{periodic}} = H_{0} + \sum_{\substack{k = 0 \\ \text{hiki} \\ k \neq 0}}^{X} t_{jk} \quad \text{if} k; \quad \text{if}$$
(6)

where hjki denotes all the new pairs of neighbors due to the periodic boundary condition. The diagonal block matrix of the H am iltonian for surface atoms is unchanged in the periodic boundary condition as opposed to BC I and Π .

III. NANOSTRUCTURE MODELING

The three boundary conditions are applied to the study of the electronic structure of a selfassem bled InAs quantum dot embedded in a G aAs bu er. The modeled dot is lens shaped with diam eter 15 nm and height 6 nm, sim ilar to experimentally available dots.[10, 11]. The appropriate size for the G aAs bu er depends on the type of calculation. For strain-prole calculations, the bu er thickness should be at least as large as the dot size since the strain eld is long-ranged, while for electronic-structure calculations the bu er thickness can be sm aller than the dot size because bound electron states are electively con ned inside the dot.[4] In this work, a 15 nm thick bu er is used for the strain-prole calculation, and a reduced bu er with thickness 1 { 5 nm is used for the electronic structure calculation with the atom ic positions given by the larger strain calculation. The equilibrium atom ic positions are calculated by m inimizing the strain energy using an atom istic valence-forceeld m odel.[3, 12, 13] The necessity of a large bu er size for the strain calculation and the long-range e ect of the strain on the electronic structure are discussed in Section IV A. Under the saturated strain prole obtained with a su ciently large bu er, the quantitative e ect of the reduced bu er size on the electronic structure is examined in Section IV E.

The tight-binding H am iltonian for the InA s dot and the G aA s bu er is constructed based on atom ic sp^3d^5s orbitals. The H am iltonian m atrix elements are obtained by tting to experimental bulk band structure parameters with a genetic optimization algorithm .[3, 14] To take into account the e ect of the displacements of atom s from the unstrained crystal positions, the atom ic energies (the diagonal elements of the H am iltonian) are adjusted by a linear correction within the Low din orthogonalization procedure.[14, 15] The coupling parameters between nearest-neighbor orbitals (the o -diagonal elements of the H am iltonian)



FIG.1: Strain proles for a lens-shaped InAs quantum dot with diameter 15 nm and height 6 nm, embedded in 3 nm and 15 nm thick GaAs bu ers. The hydrostatic strain component $(x_x + y_y + z_z)=3$ is plotted with respect to atom ic position along the growth direction from the substrate to the capping layer. The periodic boundary condition is in posed on the bu er surface. The simulation with the smallbu er underestimates the compressive strain inside the dot by 0.005 in comparison with the simulation with the large bu er. Furthermore, the smallbu er simulation predicts a tensile strain in the bu er while the large-bu er simulation predicts a compressive strain.

are also modi ed according to the generalized Harrison d 2 scaling law and Slater-Koster direction-cosine rules.[16, 17]

The eigenvalues of the tight-binding Ham iltonian is obtained with the Lanczos algorithm,[18] which is a commonly used iterative eigenvalue solver for large-dimensional, sparse, Herm itian matrices, as is the case for our tight-binding Ham iltonian. At each Lanczos iteration, the matrix is projected into a low er-dimensional subspace known as the K rylov subspace. The reduced matrix is tridiagonal and its eigenvalues approximate those of the original matrix as the size of the K rylov subspace grows.

IV. RESULTS AND DISCUSSION

A. Long-ranged Strain Field

An accurate strain pro le is a prerequisite for the electronic-structure calculation because the strain eld strongly a ects ionic potentials and thus changes the electron Ham iltonian.



FIG. 2: Energy gap between the ground electron and hole states with respect to untruncated G aAs bu er thickness. The modeled system is an InAs dot with diameter 15 nm and height 6 nm, embedded in a G aAs bu er. Both strain prole and electronic structure are calculated with the periodic boundary condition imposed on an untruncated bu er surface. The solid circle is the calculation result, and the line is an exponential t. As the bu er thickness increases and the strain in the dot saturates, the energy gap converges to 1.125 eV.



FIG.3: Conduction and valence band edges at with respect to hydrostatic strain for bulk InAs and G aAs. The compressive strain increases the direct band gap while the tensile strain decreases the gap.

In order to obtain an accurate strain pro le of InA s/G aA s nanostructures, a su ciently large G aA s bu er needs to be included in the simulation dom ain. Figure 1 shows the dram atic di erence between the strain pro les calculated with a 3 nm thick bu er and a 15 nm thick bu er. The simulation with the sm all bu er underestim ates the compressive strain inside

the dot and m is represents the strain in the bu er. The simulation with the large bu er yields the relaxation of strain at the bu er surface. The result indicates that the 15 nm thick bu er is su ciently large to accomm odate the strain relaxation that would occur in a realistically sized system.

The saturation of the strain prole can be also monitored by examining the convergence of the resulting electronic structure. Figure 2 shows the energy gap between the ground electron and hole states with respect to the buller size used for both strain and electronic structure calculations. Both the strain prole and the electronic structure are calculated with the periodic boundary condition. As the buller thickness varies from 3 nm to 15 nm, the resulting energy gap increases by about 72 m eV (from 1.051 eV to 1.123 eV). The large gap change demonstrates the long-range elect of the strain led on the electronic structure. The exponential t suggests the convergence of the gap to 1.125 eV as the buller thickness becomes in nite. Since the small buller underestimates the strain inside the dot, the increase of the buller thickness results in the increase of the dot strain. Under the compressive hydrostatic strain, the bulk G aA s and InA s conduction (valence) band edge at

shifts up (down), as shown in Figure 3. Following the trends, the lowest conduction (the highest valence) electron energy of the strained nanostructure increases (decreases) as the bu er thickness increases and the dot strain becomes stronger. These shifts of the electron energies lead to the overall increase of the energy gap. Figures 1 and 2 clearly demonstrate the importance of a su ciently large bu er size in the simulation dom ain in order to obtain both accurate strain pro le and electronic structure.

A libough the strain calculation requires a large bu er, an accurate electronic structure can be obtained with a smaller bu er due to the nite extent of the localized electron wave functions. Using a truncated bu er will ease the computational requirements for the electronic structure calculation since the dimension of the H am iltonian grows linearly with the number of atoms included in the model. From here on, the electronic structure is calculated with a truncated bu er while keeping the equilibrium atom ic positions obtained from the strain calculation using a 15 nm thick bu er and implementing the boundary conditions addressed in Section II. The e ciency and reliability of each boundary condition are systematically analyzed in terms of the elimination of non-physical surface states in Section IV B, the number of Lanczos iterations required for interior-state energy convergence in Section IV C, the insensitivity of the converged energy to the boundary energy shift in



FIG. 4: Eigenvalues of the Lanczos tridiagonal matrix versus the number of Lanczos iterations (a) without any modi cation to boundary energies, (b) with the boundary condition of raising surface-atom orbital energies (BC I), and (c) with the boundary condition of raising dangling-bond energies (BC II). The modeled system is an InAs dot with diameter 15 nm and height 6 nm, embedded in G aAs. The strain is calculated with a 15 nm thick G aAs bu er, while the electronic structure is calculated with a truncated bu er with thickness 3 nm. The energy shifts for the boundary condition are set to be (b) $_{s}=5 \text{ eV}$, $_{p}=3 \text{ eV}$, and (c) $_{sp^{3}}=5 \text{ eV}$.

Section IV D, and the bu er size required for the energy convergence in Section IV E.

B. Surface/Interface State E lim ination

One important criterion for a proper BC is the elimination of non-physical surface/interface states from the energy region of interest. Figure 4 presents the eigenvalues obtained from the Lanczos iterations when three di erent boundary conditions are applied to a 3 nm thick truncated bu er. First, to visualize the importance of having a proper boundary condition, the eigenvalues without any modi cation to the boundary energies are



FIG. 5: Eigenvalues of the Lanczos tridiagonal matrix versus the number of Lanczos iterations with the periodic boundary condition (BC III) (a) using the truncated bu erwith thickness 3 nm and (b) using the untruncated bu erwith thickness 3 nm. The di erence between the two bu ers lies in the equilibrium positions of atoms, since the former bu er uses the result of the strain calculation with a 15 nm thick bu erwhile the latter bu er uses that with a 3 nm thick bu er. The strain prole results for the two cases are shown in Fig.1.

plotted in Figure 4(a). When such a trivial boundary condition is in plan ented, many surface states are formed, which prevents the Lanczos algorithm from resolving eigenvalues for the physical interior states. By comparison, Figure 4(b) and (c) show that BC I and II remove surface states and develop an energy gap. The energy shifts used in this calculation are $_{s}=5 \text{ eV}$, $_{p}=3 \text{ eV}$, and $_{sp^{3}}=5 \text{ eV}$. BC II e ciently eliminates all non-physical surface states in the middle of the gap between about 0.3 eV and 1.2 eV. In contrast, BC I does not remove all the surface states. The dense spectrum of the remaining surface states prevents the convergence of bound hole states below 0.3 eV.

BC III is also applied to the truncated bu er to test its e ciency in interface-state elimination. Figure 5 shows the eigenvalues of the Lanczos tridiagonal matrix with the periodic boundary condition: (a) using a truncated bu erwith thickness 3 nm and (b) using an untruncated bu erwith thickness 3 nm. In the former the strain prole is calculated with a 15 nm thick bu er and then the bu er is reduced to 3 nm to calculate the electronic structure, while in the latter both the strain prole and electronic structure are calculated with a 3 nm thick bu er. In both cases, the periodic boundary condition is imposed for not



FIG.6: A tom ic positions at the boundary plane of the truncated G aA sbu er: (a) 3-D visualization of the boundary plane, (b) a slice through a plane with z about 6 nm. The plane is bent due to non-uniform strain generated by the lattice m ism atch between the InAs dot and G aA sbu er. The variation of the atom ic positions along the x axis is about 5% of the unstrained bond length of 0.24 nm.

only the electronic structure calculation but also the strain pro le. The periodic boundary condition with the truncated bu er results in m any spurious states in the m iddle of the gap, while that with the untruncated bu er does not.

The mid-gap states in the truncated-bu er sinulation are formed because of the nonplanar interface at the boundaries. A lattice mismatch of 7% between InAs and GaAs induces strain in both the InAs dot and the GaAs bu er. The strain bends the boundary plane of the truncated bu er by as much as 5% of the unstrained GaAs bond length (see Fig. 6). When the bent boundaries are connected by the periodic boundary condition, the bond between the atoms at the interface is signi cantly stretched or compressed. The strained bonds result in non-physical \interface" states in the middle of the gap. As shown in Figure 3, strain dramatically change the band structure of bulk GaAs | tensile strain reduces the band gap while compressive strain increases the gap. Similarly, the strongly strained interface in the truncated bu er yield mid-gap states. In contrast, the boundaries of the untruncated bu er are smooth due to the periodic boundary condition in posed on the strain calculation. As a result, it does not yield interface states. However, because of its inaccurate strain pro le the resulting electronic structure is also inaccurate as discussed in Section IV A.

To avoid the unrealistic interface states induced by the truncated periodic BC, the atom ic positions of the truncated bu er need to be adjusted to atten the interface.[5] However, the adjustment unavoidably leads to an inaccurate strain prole unless the truncated bu er is

TABLE I: Number of Lanczos iterations required to obtain eigenvalues converged within 0.1 eV with the boundary condition of raising orbital energies of surface atoms (BC I) and with the boundary condition of raising dangling-bond energies (BC II). The modeled system is a lens-shaped InAs quantum dot with a diameter 15 nm and height 6 nm, embedded in a 3 nm thick GaAs bu er. The strain pro le is obtained with a 15 nm thick GaAa bu er.

No.ofeigenvalues	BC I	BC II
1	1250	650
2	2320	1370
3	2400	1370
4	2420	1370

large enough for strain to saturate near the interface. We have experimented with a partial relaxation of the boundary layers but found unsatisfactory results | many interface states remain, because the partial relaxation is not su cient to atten the interface. To succeed in eliminating interface states, one should start with a larger bu er whose boundary is less strained so that the partial relaxation can lead to a at boundary.

BC I and II do not require any adjustment to the interface of the truncated buer, as opposed to BC III which requires an articial attening of the interface. Therefore, we conclude that the non-periodic BCs are more e cient than the periodic BC in terms of the elimination of surface or interface states with a smaller truncated buer while accurately incorporating the strain prole resulting from a larger-buer simulation.

C. Eigenvalue Convergence Speed

To investigate the e ciencies of BC I and II in resolving interior-state energies, the speed of the eigenvalue convergence is measured in terms of the number of Lanczos iterations required. Table I lists the number of Lanczos iterations required for a given number of converged eigenvalues for BC I and II.BC II results in a faster convergence than BC I.For example, to acquire four eigenvalues, BC II requires half as many iterations as BC I. The e ciency of BC II is attributed to the elimination of the dense spectrum of surface states. In general, iterative eigenvalue solvers easily not eigenvalues in a sparse spectrum, but show



FIG. 7: (a) E lectron energy versus dangling-bond energy shift $_{sp^3}$, (b) Variations of the ground and excited electron (e1, e2) and hole (h1, h2) energies with respect to energy shift. A energy shift larger than 5 eV eliminates surface states in the middle of the gap between 0.2 and 1.2 eV. The electron and hole energies vary only by a few meV when the energy shift varies from 5 to 20 eV.

di culty resolving eigenvalues in a dense spectrum. Therefore, the search of interior states is accelerated by the elimination of surface states from the interior-state spectrum.

D. Boundary Energy Shift

To implement BC I and II, appropriate boundary energy shifts $_{s,p}$, and $_{sp^3}$ must be determined. The ultimate goal in choosing the energy shift is to eliminate all surface states in the energy region of interest for interior states (e.g., within the band gap). Figure 7 shows converged eigenvalues with respect to the energy shift $_{sp^3}$ in BC II.W hile $_{sp^3} = 3 \text{ eV}$ leads to surface states in the middle of the gap, the energy shift larger than 5 eV eliminates all the surface states and leads to the eigenvalues converged within a few m eV. This indicates that the electronic structure is insensitive to the choice of the energy shift in BC II if the shift is big enough to remove all surface states.

In contrast, the e ect of energy shifts on the electronic structure with BC I is highly unpredictable; a slight change of the shifts leads to a completely di erent Lanczos eigenvalue spectrum. For instance, changing $_{\rm p}$ from 3 eV to 4 eV results in more surface states within the gap, as shown in Figure 8. A wide range of positive and negative energy shifts $_{\rm s}$ and $_{\rm p}$ was tested to achieve the best perform ance for elim inating surface states. How ever, no pair



FIG.8: Eigenvalues of the Lanczos tridiagonal matrix versus the number of Lanczos iterations with the boundary condition of raising orbital energies (BC I), (a) using $_{s}=5 \text{ eV}$ and $_{p}=3 \text{ eV}$, (b) using $_{s}=5 \text{ eV}$ and $_{p}=4 \text{ eV}$, and (c) using $_{s}=20 \text{ eV}$ and $_{p}=20 \text{ eV}$. We have not found any pair of $_{s}$ and $_{p}$ that succeeds in removing all the surface states in the middle of the gap which is between 0.2 and 1.2 eV.

oftested $_{s}$ and $_{p}$ within 20 eV succeeded in eliminating all the surface states and in yielding the band gap 1.1 eV which is given by both BC II with a truncated bu er (see Fig. 4 (c)) and BC III with an untruncated bu er (see Fig. 5 (b)). This ine ciency in removing surface states is attributed to the truncation of connected bonds. BC I truncates both dangling bonds and connected bonds, while BC II truncates only the dangling bonds. Since the connected bond should be connected to interior atom s, the truncation of the connected bond will create a dangling bond to the interior atom s, and the dangling bond gives rise to surface states within the gap. This result suggests that BC I has intrinsic di culties in rem oving surface states.



FIG.9: Variations of the energy gap (E_{gap}) between the ground electron and hole states, the energy spacing (E_{electron}) between the ground and the rst excited electron states, and the energy spacing (E_{hole}) between the ground and the rst excited hole states, with respect to the truncated bu er thickness for an InAs quantum dot with diam eter 15 nm and height 6 nm. The boundary condition of raising dangling-bonds energies (BC II) with $_{sp^3}=10$ eV is used for this calculation. E_{gap}, E_{electron}, and E_{hole} with each bu er thickness are subtracted by those with bu er thickness 5 nm to obtain the variations of these quantities. As the bu er thickness becomes larger than 3 nm, E_{gap}, E_{electron}, and E_{hole} converge to 1123 meV, 56 meV, and 14 meV within 1 meV, respectively.

E. Bu er Size

To nd a reasonable bu er size for accurate electronic-structure calculations, the quantitative dependence of the electronic structure on the bu er size is exam ined. BC II is used since it provides the most e cient elimination of non-physical states. Figure 9 presents the energy gap between the lowest conduction electron and the highest valence electron levels for di erent bu er thicknesses. The bu er thickness is de ned as the distance between the faces of the bu er G aAs box and the InAs dot. When the bu er thickness is bigger than 3 nm, the energy gap and the electron and hole energy spacings converge to 1123 m eV, 56 m eV, and 14 m eV within 1 m eV, respectively. This convergence indicates that a 3 nm thick bu er is large enough to obtain the electronic structure with the accuracy of 1 m eV. In general, the optim al bu er size varies with quantum -dot size and electron level, and hence one should determ ine the optim al size by monitoring the convergence of the energies for a desired accuracy.

V. CONCLUSIONS

In sum mary, we have investigated three types of boundary conditions for the electronic structure of a self-assembled InAs dot embedded in GaAs within the fram ework of the empirical tight-binding model. Two non-periodic boundary conditions demonstrate higher e ciency than the truncated periodic boundary condition, in term softhe bu er size required to elim inate non-physical mid-gap states. Between the non-periodic boundary conditions, BC II (raising dangling-bond energies) more e ciently removes surface states than BC I (raising orbital energies of surface atom s). Therefore, BC II is identi ed as the most e cient boundary condition for elim inating surface states and achieving the convergence of interior-state energies with a truncated bu er.

The e ect of the dangling-bond energy shift and the bu er size on the electronic structure have been further examined with the e cient BC II. An energy shift bigger than 5 eV e ciently removes all spurious states in the middle of the gap, and yields an energy gap insensitive to the further increase of the energy shift. For a lens-shaped InAs dot with diam eter 15 nm and height 6 nm, the GaAs bu er thickness of 3 nm is large enough to obtain the electronic structure with the accuracy of 1 m eV.

W hile our new boundary condition (BC II) has been developed within the fram ework of empirical tight binding, it can be extended to other models. An example is to use an empirical pseudo-potential with a non-local part that is a sum of projections on sub-spaces with well-de ned orbital momentum .[19] In this case, a transform ation of the basis set to the sp³ hybridized orbitals can be performed and an energy shift can be applied solely to the dangling bonds as presented in this work.

Boundary condition II with a truncated bu er takes advantage of the localization of the electron wave functions in a core nanostructure such as the InAs/GaAs quantum dot illustrated in this article. This scheme is not straightforwardly applicable to other types of heterostructures where electrons or holes are localized in the bu er. However, if the core nanostructure is larger than the extent of the electron or hole wave function localized in the bu er, one can truncate the core region instead of the bu er. W hen one of the carriers (electron or hole) is localized in the core and the other carrier in the bu er, the core carrier can be modeled with a truncated bu er and the bu er carrier with a truncated core, so long as the coupling between the conduction and valence bands is weak enough to treat the electron and hole H am iltonians independently.

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